

RGP10A - RGP10M

Features

- 1.0 ampere operation at T_A = 55°C with no thermal runaway.
- High temperature metallurgically bonded construction.
- Glass passivated cavity-free junction.
- Typical I_p less than 1μA.
- Fast switching for high efficiency.



COLOR BAND DENOTES CATHODE

Fast Rectifiers (Glass Passivated)

Absolute Maximum Ratings* T_A = 25°C unless otherwise noted

Symbol	Parameter	Value			Units				
		10A	10B	10D	10G	10J	10K	10M	
V_{RRM}	Maximum Repetitive Reverse Voltage	50	100	200	400	600	800	1000	V
I _{F(AV)}	Average Rectified Forward Current, .375 " lead length @ T _L = 55°C	1.0			А				
I _{FSM}	Non-repetitive Peak Forward Surge Current 8.3 ms Single Half-Sine-Wave			А					
T _{stg}	Storage Temperature Range -65 to +175			°C					
T _J	Operating Junction Temperature -65 to +175			°C					

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

Thermal Characteristics

Symbol	Parameter	Value	Units
P_{D}	Power Dissipation	3.0	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	50	°C/W

Electrical Characteristics T_A = 25°C unless otherwise noted

Symbol	Parameter	Device					Units		
		10A	10B	10D	10G	10J	10K	10M	
V_{F}	Forward Voltage @ 1.0 A	1.3				V			
t _{rr}	Reverse Recovery Time $I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$	150 25			250	500		ns	
I _R	Reverse Current @ rated V_R $T_A = 25^{\circ}C$ $T_A = 150^{\circ}C$	5.0 200			μA μA				
Ст	Total Capacitance V _R = 4.0 V, f = 1.0 MHz	15			pF				

Typical Characteristics

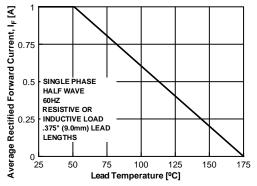
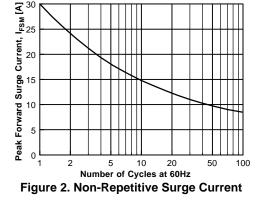


Figure 1. Forward Current Derating Curve



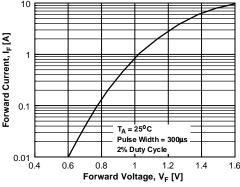


Figure 3. Forward Voltage Characteristics

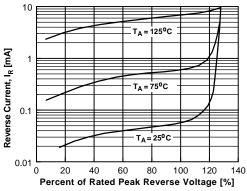


Figure 4. Reverse Current vs Reverse Voltage

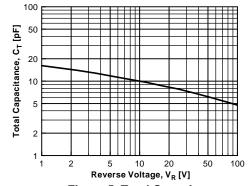
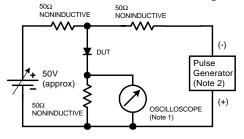
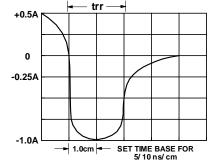


Figure 5. Total Capacitance





Reverse Recovery Time Characterstic and Test Circuit Diagram

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